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IGBT with Monolithic Free Wheeling Diode

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop (FS) Trench construction, and provides superior performance in demanding switching applications, offering both low on–state voltage and minimal switching loss. The IGBT is well suited for resonant or soft switching applications.

Features

- Extremely Efficient Trench with Fieldstop Technology
- 1350 V Breakdown Voltage
- Optimized for Low Case Temperature in IH Cooker Application
- Reliable and Cost Effective Single Die Solution
- These are Pb-Free Devices

Typical Applications

- Inductive Heating
- Consumer Appliances
- Soft Switching

ABSOLUTE MAXIMUM RATINGS

Symbol V _{CES}	Value	Unit
V _{CES}		
	1350	V
I _C	30 15	A
I _{CM}	60	A
I _F	30 15	A
I _{FM}	60	A
V _{GE}	±20 ±25	V
P _D	357 178	W
Τ _J	-40 to +175	°C
T _{stg}	–55 to +175	°C
T _{SLD}	260	°C
	I _{CM} I _F V _{GE} P _D T _J	$\begin{array}{c c} & 30 \\ 15 \\ \hline \\ I_{CM} & 60 \\ \hline \\ I_F & 30 \\ 15 \\ \hline \\ I_{FM} & 60 \\ \hline \\ V_{GE} & \pm 20 \\ \pm 25 \\ \hline \\ P_D & 357 \\ 178 \\ \hline \\ T_J & -40 \text{ to } +175 \\ \hline \\ \hline \\ T_{stg} & -55 \text{ to } +175 \\ \hline \end{array}$

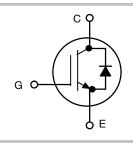
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

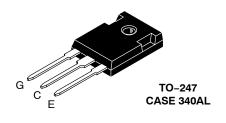


ON Semiconductor®

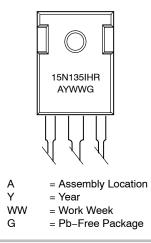
http://onsemi.com

15 A, 1350 V V_{CEsat} = 2.15 V E_{off} = 0.42 mJ





MARKING DIAGRAM



ORDERING INFORMATION

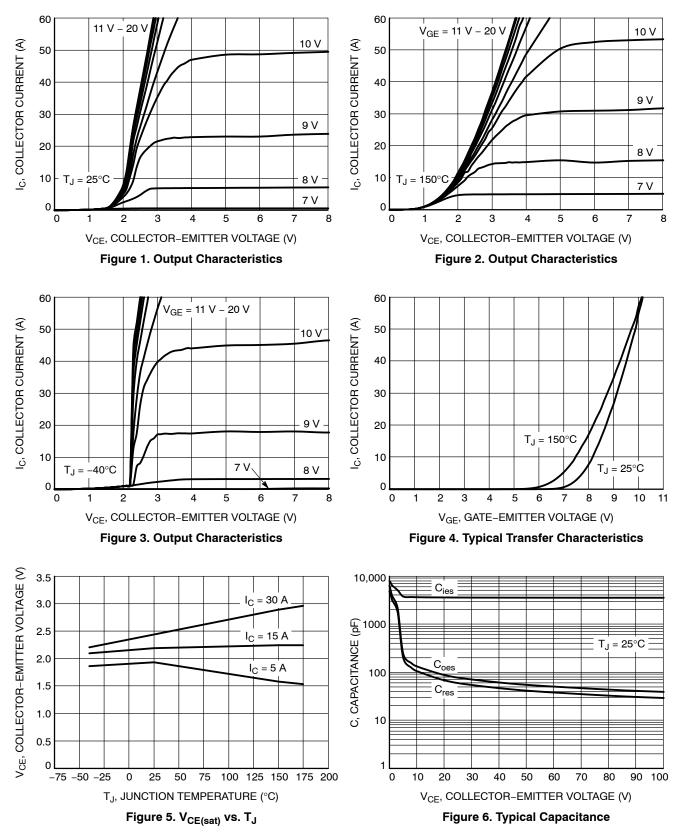
Device	Package	Shipping
NGTB15N135IHRWG	TO–247 (Pb–Free)	30 Units / Rail

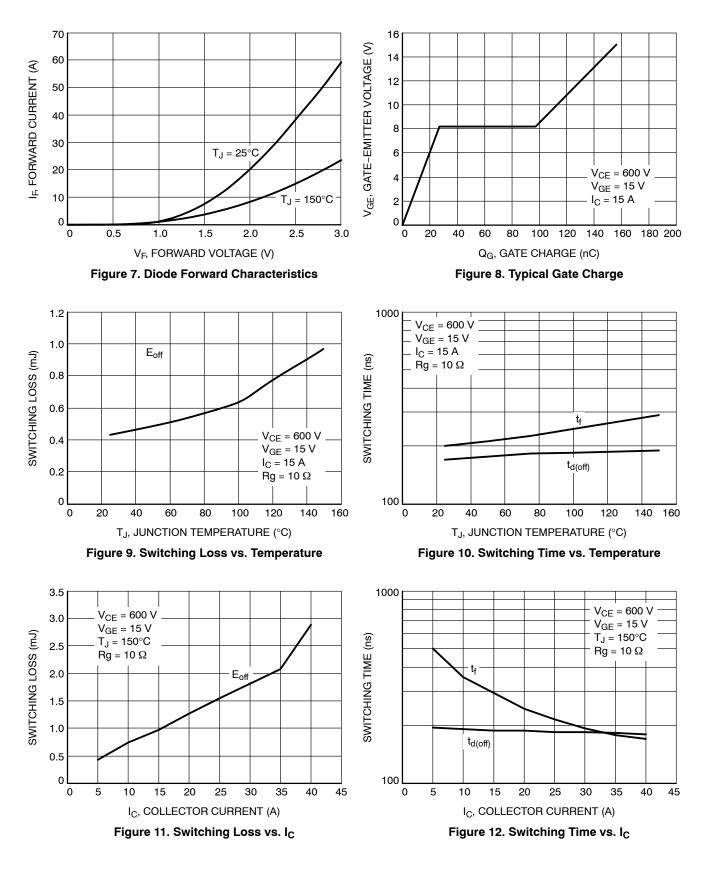
THERMAL CHARACTERISTICS

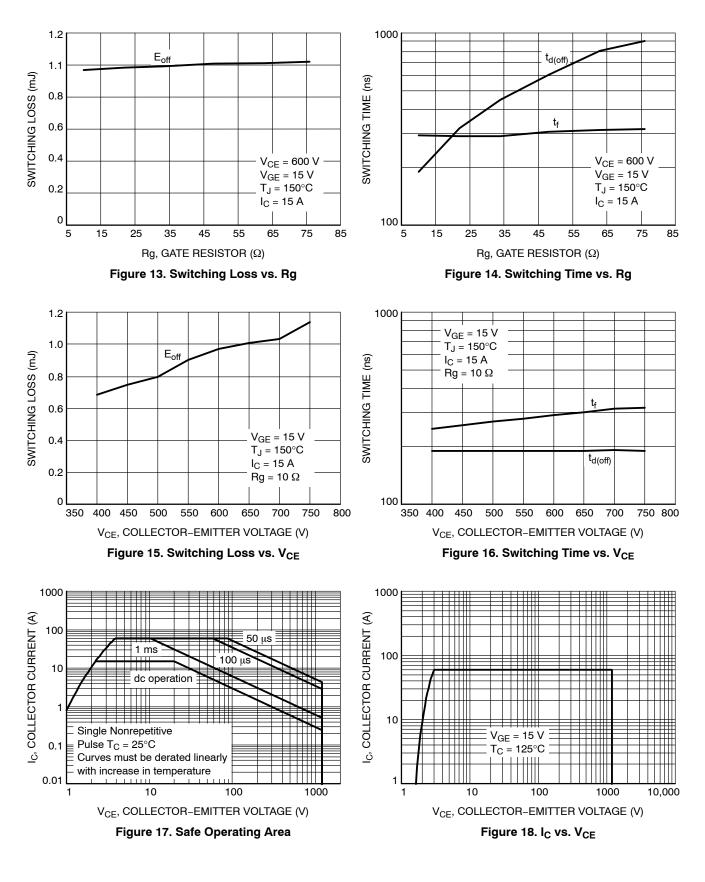
Rating	Symbol	Value	Unit
Thermal resistance junction-to-case	$R_{ ext{ heta}JC}$	0.42	°C/W
Thermal resistance junction-to-ambient	$R_{\theta JA}$	40	°C/W

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC	•				•	
Collector-emitter breakdown voltage, gate-emitter short-circuited	V_{GE} = 0 V, I _C = 500 μ A	V _{(BR)CES}	1350	-	_	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 15 A V _{GE} = 15 V, I _C = 15 A, T _J = 175°C	V _{CEsat}		2.15 2.25	2.65 -	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_C = 250 \ \mu A$	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	V _{GE} = 0 V, V _{CE} = 1350 V	I _{CES}	-	-	0.1	mA
Gate leakage current, collector-emitter short-circuited	V_{GE} = 20 V, V_{CE} = 0 V	I _{GES}	_	-	100	nA
DYNAMIC CHARACTERISTIC					•	
Input capacitance	V _{CE} = 20 V, V _{GE} = 0 V, f = 10 kHz	C _{ies}	-	3560	-	pF
Output capacitance		C _{oes}	-	87	-	
Reverse transfer capacitance		C _{res}	-	68	-	
Gate charge total		Qg	-	156	-	nC
Gate to emitter charge	V_{CE} = 600 V, I _C = 15 A, V _{GE} = 15 V	Q _{ge}	-	27	-	
Gate to collector charge		Q _{gc}	-	70	-	
SWITCHING CHARACTERISTIC, INDUCT						
Turn-off delay time	T _J = 25°C	t _{d(off)}	-	170	-	ns
Fall time	$V_{CC} = 600 V, I_C = 15 A$ $R_g = 10 \Omega$ $V_{GE} = 0 V/ 15V$	t _f	-	200	-	
Turn-off switching loss		E _{off}	-	0.42	-	mJ
Turn-off delay time	T _J = 150°C V _{CC} = 600 V, I _C = 15 A R _g = 10 Ω	t _{d(off)}	-	190	-	ns
Fall time		t _f	-	290	-	
Turn-off switching loss	V _{GE} = 0 V/ 15V	E _{off}	-	0.95	-	mJ
DIODE CHARACTERISTIC						
Forward voltage	V_{GE} = 0 V, I _F = 15 A, T _J = 25°C V _{GE} = 0 V, I _F = 15 A, T _J = 175°C	V _F	-	1.85 2.75	2.10 _	V







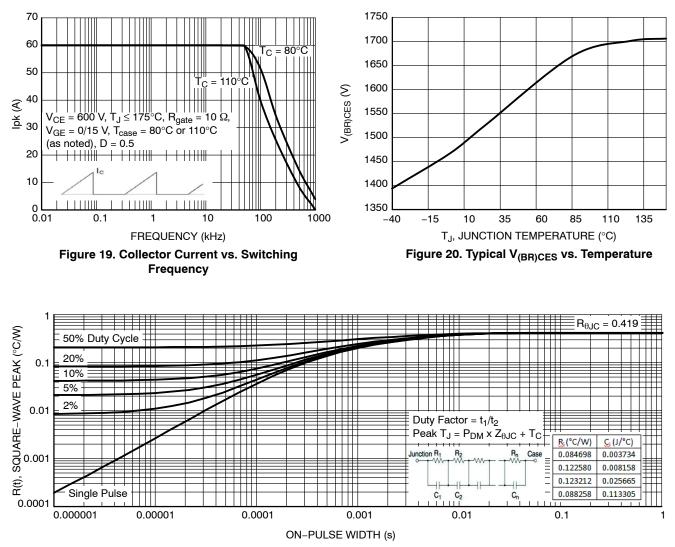


Figure 21. IGBT Transient Thermal Impedance

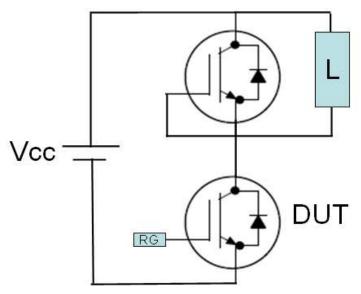
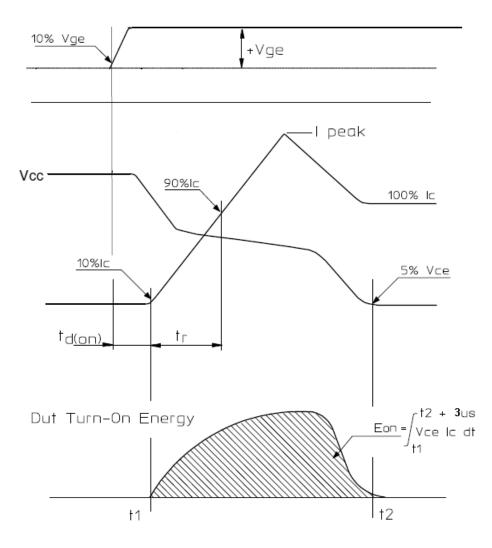
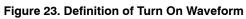
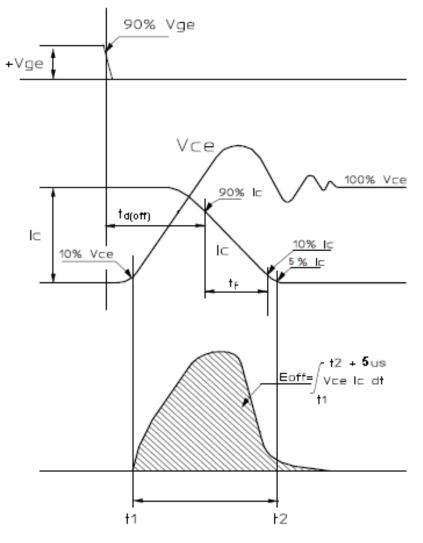
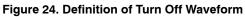


Figure 22. Test Circuit for Switching Characteristics



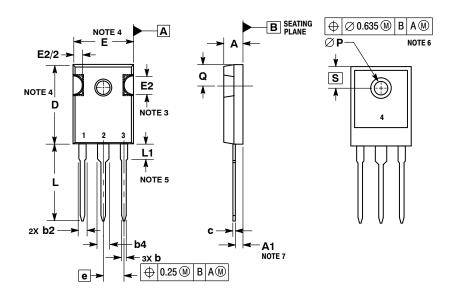






PACKAGE DIMENSIONS

TO-247 CASE 340AL **ISSUE A**



NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS. SLOT REQUIRED, NOTCH MAY BE ROUNDED. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.13 PER SIDE. THESE 3
- DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREME OF THE PLASTIC BODY LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY
- 11 ØP SHALL HAVE A MAXIMUM DRAFT ANGLE OF 1.5° TO THE 6.
- TOP OF THE PART WITH A MAXIMUM DIAMETER OF 3.91. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED 7

BY L1.			
	MILLIMETERS		
DIM	MIN	MAX	
Α	4.70	5.30	
A1	2.20	2.60	
b	1.00	1.40	
b2	1.65	2.35	
b4	2.60	3.40	
C	0.40	0.80	
D	20.30	21.40	
Е	15.50	16.25	
E2	4.32	5.49	
е	5.45	BSC	
L	19.80	20.80	
L1	3.50	4.50	
Ρ	3.55	3.65	
Q	5.40	6.20	
S	6.15 BSC		

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